

Objectives

IEEE 802.3 802.3df Task Force

**John D'Ambrosia,
Acting Chair, IEEE P802.3df Task Force
Futurewei, U.S. Subsidiary of Huawei**

10 Dec 2021

IEEE P802.3 df Objectives

- **Non-Rate Specific**
 - Support full-duplex operation only
 - Preserve the Ethernet frame format utilizing the Ethernet MAC
 - Preserve minimum and maximum FrameSize of current IEEE 802.3 standard
 - Support a BER of better than or equal to 10^{-13} at the MAC/PLS service interface (or the frame loss ratio equivalent)
 - Provide support to enable mapping over OTN
- **200 Gb/s Related**
 - Support a MAC data rate of 200 Gb/s
 - Support optional single-lane 200 Gb/s attachment unit interfaces for chip-to-module and chip-to-chip applications
 - Define a physical layer specification that supports 200 Gb/s operation:
 - over 1 pair of copper twin-axial cables in each direction with a reach of up to at least 1.0 meter
 - over 1 pair of SMF with lengths up to at least 500 m
 - over 1 pair of SMF with lengths up to at least 2 km
- **400 Gb/s Related**
 - Support a MAC data rate of 400 Gb/s
 - Support optional two-lane 400 Gb/s attachment unit interfaces for chip-to-module and chip-to-chip applications
 - Define a physical layer specification that supports 400 Gb/s operation:
 - over 2 pairs of copper twin-axial cables in each direction with a reach of up to at least 1.0 meter
 - over 2 pairs of SMF with lengths up to at least 500 m

IEEE P802.3 df Objectives

- **800 Gb/s Related**

- Support a MAC data rate of 800 Gb/s
- Support optional eight-lane 800 Gb/s attachment unit interfaces for chip-to-module and chip-to-chip applications
- Support optional four-lane 800 Gb/s attachment unit interfaces for chip-to-module and chip-to-chip applications
- Define a physical layer specification that supports 800 Gb/s operation:
 - over 4 pairs of copper twin-axial cables in each direction with a reach of up to at least 1.0 meter
 - over eight lanes of twin axial copper cables with a reach up to at least 2 meters
 - over eight lanes over electrical backplanes supporting an insertion loss $\leq 28\text{dB}$ at 26.56GHz
 - over 8 pairs of MMF with lengths up to at least 50 m
 - over 8 pairs of MMF with lengths up to at least 100 m
 - over 8 pairs of SMF with lengths up to at least 500 m
 - over 8 pairs of SMF with lengths up to at least 2 km
 - over 4 pairs of SMF with lengths up to at least 500 m
 - over 4 pairs of SMF with lengths up to at least 2 km
 - over 4 wavelengths over a single SMF in each direction with lengths up to at least 2 km
 - over a single SMF in each direction with lengths up to at least 10 km
 - over a single SMF in each direction with lengths up to at least 40 km

IEEE P802.3 df Objectives

- **1.6 Tb/s Related**

- Support a MAC data rate of 1.6 Tb/s
- Support optional sixteen-lane 1.6 Tb/s attachment unit interfaces for chip-to-module and chip-to-chip applications
- Support optional eight-lane 1.6 Tb/s attachment unit interfaces for chip-to-module and chip-to-chip applications
- Define a physical layer specification that supports 1.6 Tb/s operation:
 - over 8 pairs of copper twin-axial cables in each direction with a reach of up to at least 1.0 meter
 - over 8 pairs of SMF with lengths up to at least 500 m
 - over 8 pairs of SMF with lengths up to at least 2 km

Adoption History

Approved by IEEE 802.3 WG

19 Nov 2021